

US00RE40211E

(19) United States

(12) Reissued Patent

Urano et al.

(10) Patent Number:

US RE40,211 E

(45) Date of Reissued Patent:

Apr. 1, 2008

(54) **DIAZODISULFONES**

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(21) Appl. No.: 09/810,650

(22) Filed: Mar. 15, 2001

Related U.S. Patent Documents

Reissue of:

(64) Patent No.: 5,216,135
Issued: Jun. 1, 1993
Appl. No.: 07/962,089
Filed: Oct. 16, 1992

U.S. Applications:

(63) Continuation of application No. 07/646,909, filed on Jan. 28, 1991, now abandoned.

(30) Foreign Application Priority Data

(51) **Int. Cl.**

 $C07C \ 245/12$ (2006.01) $C07C \ 245/16$ (2006.01)

(52) **U.S. Cl.** **534/556**; 534/558; 534/565

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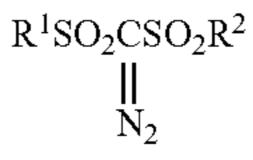
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Primary Examiner—Laura L. Stockton

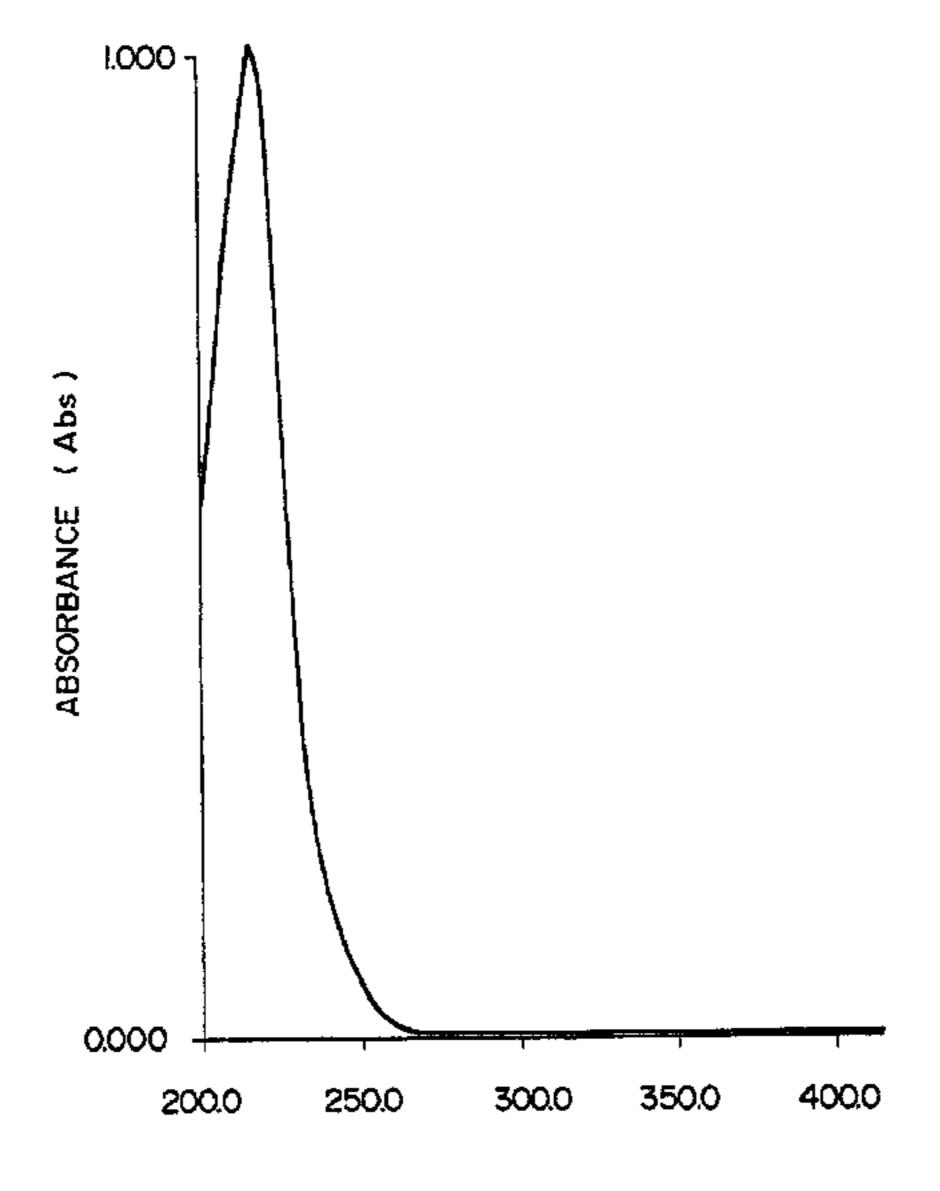
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(57) ABSTRACT



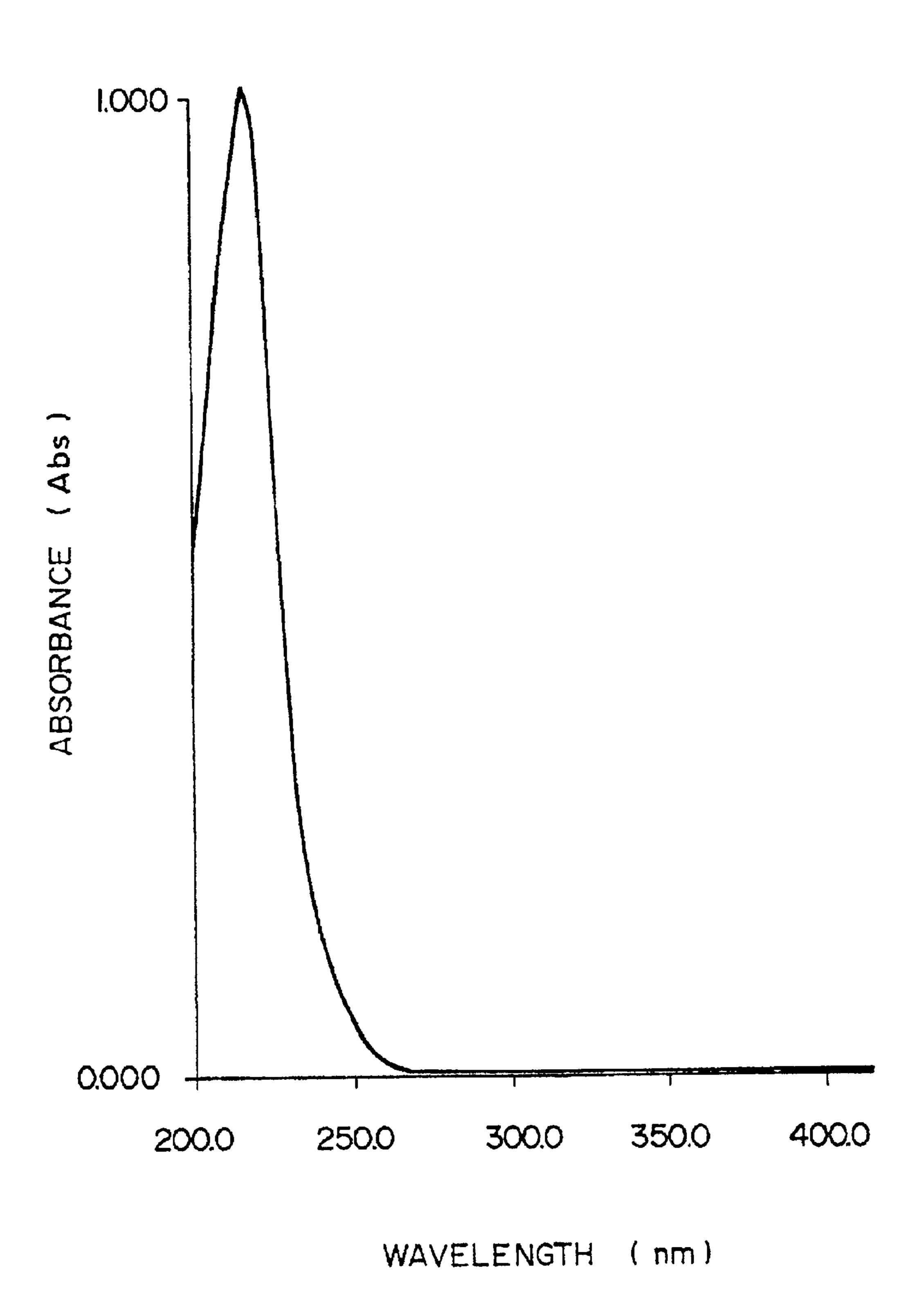
wherein R^1 is a C_{3-8} branched or cyclic alkyl group, and R^2 is a C_{1-8} straight-chain, branched or cyclic alkyl group, is effective as a photoacid generator when used in a photoresist material for light of 300 nm or less.

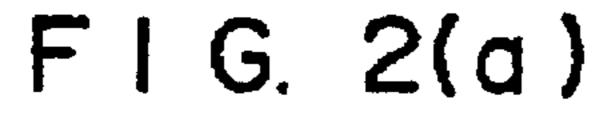
1 Claim, 2 Drawing Sheets

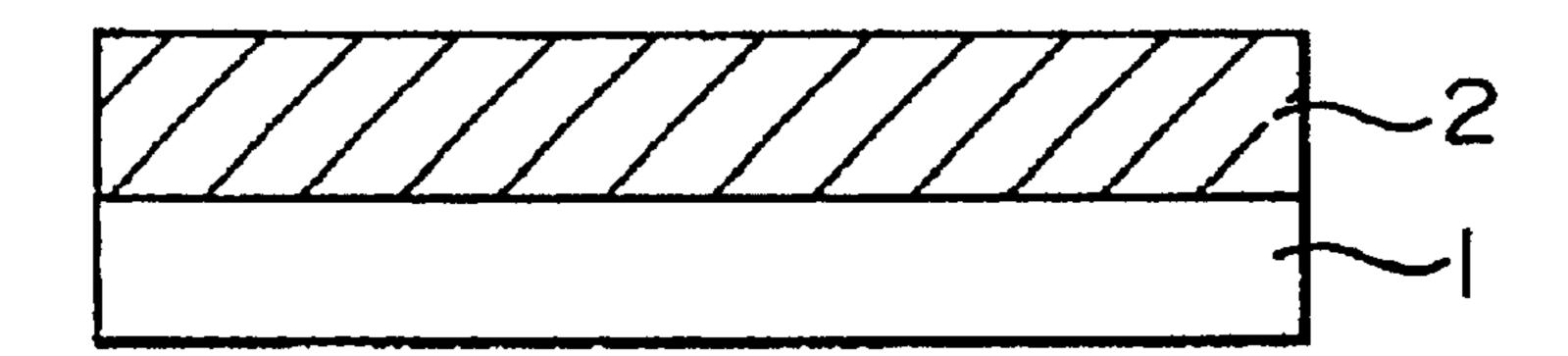


WAVELENGTH (nm)

FIG. 1

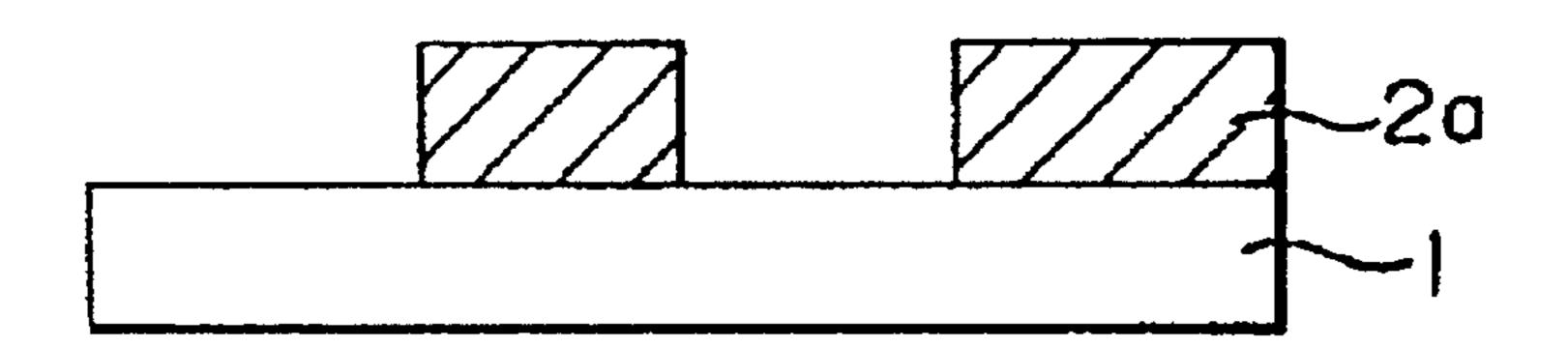






F I G. 2(b)

F I G. 2(c)



Matter enclosed in heavy brackets [] appears in the original patent but forms no part of this reissue specifi-

made by reissue.

This application is a continuation of application Ser. No. 646,909 filed Jan. 28, 1991 now abandoned.

cation; matter printed in italics indicates the additions 5

This application is a reissue application of U.S. Pat. No. 5,216,135, issued Jun. 1, 1993, and has been merged with 10 reexamination application 90/004,812 filed Oct. 23, 1997. Application 11/410,338 filed Apr. 25, 2006, now abandoned, and Application 11/714,265 filed Mar. 6, 2007 are divisional reissues of the present reissue application.

BACKGROUND OF THE INVENTION

This invention relates to a diazodisulfone compound useful as a photosensitive material for deep ultraviolet (UV) light, electron beams, X-rays, etc. More particularly, the present invention relates to a diazodisulfone compound 20 which generates an acid by irradiating with KrF excimer laser light (248.4 nm), ArF excimer laser light (193 nm), electron beams, X-rays, etc.

With recent higher density and larger scale integration of semiconductor devices, wavelengths used in exposing devices for minute processing, particularly for lithography become shorter and shorter. Now, KrF excimer laser light (248.4 nm) is studied. In order to use the KrF excimer laser as a light source, a resist material is required to act highly 30 sensitively to light exposed.

One method for making the resist material highly sensitive is to contain therein a compound which has a property of generating an acid when exposed to light, that is, to use a so-called chemical amplified resist material [e.g. H. Ito et 35] al: Polym. Eng. Sci., vol. 23, 1012 (1983)]. As the compound generating an acid by exposing to light (hereinafter referred to as "photoacid generator"), there are proposed onium salts such as allyl diazonium sails, diallyl iodonium and 4,603,101, Japanese Patent Examined Publication No. 2-27660, Japanese Patent Unexamined Publication No. 62-115440), 2,6-dinitrobenzyl tosylate [e.g. F.M. Houlihan, et al: SPIE, vol. 920, Advances in Resist Technology and Processing V, page 67 (1988)]. But, since these compounds 45 used as the photoacid generator have aromatic rings, there is a problem in that resist materials containing these compounds lower transmittance for light. Further, in the case of onium salts, resist materials containing onium salts have a problem in that the resist materials are poor in solution stability during storage.

Therefore, a resist material overcoming the problem of poor solution stability caused by a property of photoacid generator, and improving transmittance for deep UV light and KrF excimer laser light is desired.

SUMMARY OF THE INVENTION

It is an object of the present invention to provide a diazodisulfone compound used as an photoacid generator overcoming the problems mentioned above, having high 60 transmittance for light of 300 nm or less, e.g. deep UV light, KrF excimer laser light, ArF excimer laser light, generating easily an acid by exposure to the light mentioned above or by irradiation with electron beams, X-rays, etc., being excellent in solution stability in the resist material, and 65 having a function of improving a dissolution inhibiting effect of the resist material for an alkali developing solution.

The present invention provides a diazodisulfone compound of the formula:

$$\begin{array}{c} R^1SO_2CSO_2R^2 \\ \parallel \\ N_2 \end{array}$$

wherein R¹ is a branched or cyclic alkyl group having 3 to 8 carbon atoms; and R² is a straight-chain, branched or cyclic alkyl group having 1 to 8 carbon atoms.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a graph showing a UV spectral curve of an acetonitrile solution of bis-cyclohexylsulfonyl diazomethane obtained in Example 1.

FIGS. 2(a) to 2(c) are schematic cross-sectional views explaining a positive tone pattern forming process using a resist material containing the compound of the present invention as an photoacid generator.

DESCRIPTION OF THE PREFERRED **EMBODIMENTS**

The diazodisulfone compound of the formula:

$$\begin{array}{c} R^1SO_2CSO_2R^2 \\ \parallel \\ N_2 \end{array} \tag{I}$$

wherein R¹ is a branched or cyclic alkyl group having 3 to 8 carbon atoms; and R² is a straight-chain, branched or cyclic alkyl group having 1 to 8 carbon atoms, has high transmittance for light of 300 nm or less, e.g. deep UV light, KrF excimer laser light, etc., generates an acid easily by exposure to such light or by irradiation with electron beams, X-rays, etc., the acid generated functioning effectively on chemical amplification of the resist material with heating, salts, triallyl sulfonium salts (e.g. U.S. Pat. Nos. 4,491,628 40 and is excellent by itself in solution stability in the resist material.

In the formula (I), the alkyl group in the definition of R¹ includes, for example, an isopropyl group, an isobutyl group, a sec-butyl group, a tert-butyl group, an isoamyl group, a sec-amyl group, a 2-methylbutyl group, a 2-methyl-2-butyl group, a 1,1-dimethybutyl group, a 2-hexyl group, a 1,1-dimethylpentyl group, a 1,1-dimethylhexyl group, a cyclopropyl group, a cyclopentyl group, a cyclohexyl group, a cycloheptyl group, a cyclooctyl group, etc. The alkyl group in the definition of R² includes, for example, a methyl group, an ethyl group, a n-propyl group, an isopropyl group, a cyclopropyl group, a n-butyl group, an isobutyl group, a sec-butyl group, a tert-butyl group, an n-amyl group, an isoamyl group, a sec-amyl group, a 2-methylbutyl group, a 55 2-methyl-2-butyl group, a cyclopentyl group, a n-hexyl group, a cyclohexyl group, a n-heptyl group, a n-octyl group, etc.

Preferable examples of the diazodisulfones of the formula (I) are as follows.

Bis(cyclohexylsulfonyl)diazomethane Cyclohexylsulfonylethylsulfonyldiazomethane Bis(isopropylsulfonyl)diazomethane Bis(tert-butylsulfonyl)diazomethane Bis(sec-butylsulfonyl)diazomethane tert-Butylsulfonylmethylsulfonyldiazomethane tert-Butylsulfonylcyclohexylsulfonyldiazomethane Bis(cyclopentylsulfonyl)diazomethane

Cyclopentylsulfonyl-tert-butylsulfonyldiazomethane Bis(isoamylsulfonyl)diazomethane, etc.

The compound of the formula (I) has a bulky group of a branched or cyclic alkyl group at at least one of R¹ and R², so that it per se has a property of low insolubility in an alkali developing solution. Therefore, a resist material containing such a compound is consequently lowered in solubility in an alkali developing solution, resulting in increasing a dissolution inhibiting effect on so-called non-exposed portions. Such a resist material is more preferable as a pattern forming 10 material.

On the other hand, when both R¹ and R² in the formula (I) have no bulky groups in contrast to the definitions in the present invention, for example, R¹ and R² are ethyl groups, such a compound has a property of generating an acid by exposure to KrF excimer laser light, and also has a property of being dissolved by itself in the alkali developing solution used for pattern formation. Thus, when such a compound is used as an photoacid generator in a chemical amplified resist material and subjected to pattern formation, both exposed portions and non-exposed portions are dissolved in the alkali developing solution, resulting in failing to conduct good pattern formation.

The compound of the formula (I) can be synthesized easily as follows.

For example, when $R^1=R^2$, the compound of the formula (I) can be synthesized by the following reaction scheme (1):

This is explained in detail as follows. The compound of the formula:

$$R^1SH$$
 (II)

wherein R¹ is as defined above, is reacted with methylene 45 chloride in an organic solvent in the presence of a base to yield the compound of the formula:

$$R^1SCH_2SR^1$$
 (III)

wherein R¹ is as defined above.

As the base, there can be used NaOH, KOH, NaH, sodium methoxide, sodium ethoxide, pyridine, piperidine, morpholine, triethylamine, N-methylpyrrolidine,

As the organic solvent, there can be used alcohols such as methanol, ethanol, propanol, isopropenol, etc.; aromatic hydrocarbons such as benzene, toluene, etc.; cyclic ethers such as 1,4-dioxane, tetrahydrofuran (THF), etc.

Methylene chloride is used usually in an amount of 1 to 60 20 moles, preferably 5 to 15 moles, per mole of the compound of the formula (I).

The reaction is carried out usually at 20° to 100° C., preferably at 25° to 65° C. for usually 1 to 20 hours, preferably 2 to 10 hours.

The resulting compound of the formula (III) is purified by a conventional method.

4

The compound of the formula (III) is, then, reacted with hydrogen peroxide in a solvent in the presence of a catalyst to yield the compound of the formula:

$$R^1SO_2CH_2SO_2R^1$$
 (IV)

wherein R¹ is as defined above.

The hydrogen peroxide is used usually in an amount of 1 to 10 moles, preferably 2 to 6 moles, per mole of the compound of the formula (III).

As the catalyst, there can be used sodium tungstate, ammonium phosphomolibdate, etc.

As the solvent, there can be used water; alcohols such as methanol, ethanol, propanol, isopropanol, etc.; a mixed solvent of water and an alcohol, etc.

The reaction is carried out usually at 0° to 100° C., preferably at 20° to 80° C., for usually 1 to 20 hours, preferably 1 to 10 hours.

The resulting compound of the formula (IV) is purified by a conventional method.

Then, the compound of the formula (IV) is reacted with tosyl azide in a solvent in the presence of a base to yield the compound of the formula:

$$\begin{array}{c} R^1 SO_2 CSO_2 R^1 \\ \parallel \\ N_2 \end{array} \tag{V}$$

wherein R¹ is as defined above.

The tosyl azide is used usually in an amount of 0.5 to 5 moles, preferably 0.5 to 2 moles, per mole of the compound of the formula (IV).

As the base, there can be used NaOH, KOH, NaH, sodium methoxide, sodium ethoxide, pyridine, piperidine, R¹SO₂CSO₂R¹ 35 morpholine, triethylamine, N-methylpyrrolidine, etc.

As the solvent, there can be used water; water-soluble organic solvents such as methanol, ethanol, propanol, isopropanol, acetone, 1,4-dioxane, etc.; and a mixed solvent of water and a water-soluble organic solvent.

The reaction is carried out usually at 0° to 50° C., preferably at 5° to 30° C., for usually 1 to 20 hours, preferably 1 to 10 hours.

The resulting compound of the formula (V) is purified by a conventional method.

When R¹ and R² are different, the compound of the formula (I) can be synthesized easily by the following reaction scheme (2):

This is explained in detail as follows.

The compound of the formula (II) in an amount of 1 mole is mixed with usually 0.5 to 10 moles, preferably 0.5 to 2 moles of paraformaldehyde (e.g. n=3), followed by introduction of HCl gas in an amount of equimolar or mole of the paraformaldehyde at usually 10° C. or lower, preferably -10° to +5° C. Then, anhydrous calcium chloride is added

to the resulting mixture to carry out the reaction at usually 10° C. or lower, preferably -10° to +5° C., for usually 1 to 20 hours, preferably 1 to 10 hours, followed by purification by a conventional method to yield the compound of the formula:

$$R^1SCH_2Cl$$
 (VI)

wherein R¹ is as defined above.

The compound of the formula (VI) is then reacted with the $_{10}$ compound of the formula:

$$R^2SH$$
 (VII)

wherein R² is as defined above but different from R¹, in a solvent in the presence of a base to yield the compound of 15 the formula:

$$R^1SCH_2SR^2$$
 (VIII)

The compound of the formula (VI) is used in an amount 20 of usually 0.5 to 5 moles, preferably 0.5 to 2 moles, per mole of the compound of the formula

As the base, there can be used NaOH, KOH, NaH, sodium methoxide, sodium ethoxide, etc.

As the solvent, there can be used alcohols such as ²⁵ methanol, ethanol, isopropanol, etc.

The reaction is carried out usually at 0° to 50° C., preferably at 0° to 20° C., for usually 1 to 20 hours, preferably 1 to 10 hours.

The resulting compound of the formula (VIII) is purified ³⁰ by a conventional method.

The compound of the formula (VIII) is oxidized with hydrogen peroxide, followed by diazotization with tosylazide, in the same manner as described in the reaction scheme (1) to yield the compound of the formula (I).

The compound of the formula (VIII) can also be synthesized by the following reaction scheme (3):

$$R^{1}SH + R^{2}SH \xrightarrow{CH_{2}Cl_{2}} R^{1}SCH_{2}SR^{2} \xrightarrow{H_{2}O_{2}} 40$$

$$(II) \quad (VII) \qquad (VIII)$$

$$CH_{3} \xrightarrow{CH_{3}} SO_{2}N_{3}$$

$$R^{1}SO_{2}CH_{2}SO_{2}R^{2} \xrightarrow{base} R^{1}SO_{2}CSO_{2}R^{2} \xrightarrow{45}$$

$$\parallel N_{2}$$

This is explained in detail as follows.

The compound of the formula (II) is reacted with the compound of the formula (VII) and methylene chloride in a solvent in the presence of a base to yield the compound of the formula (VIII).

The compound of the formula (VII) is used usually in an amount of 0.5 to 5 moles, preferably 0.5 to 2 moles, per mole of the compound of the formula (II), and methylene chloride is used usually in an amount of 1 to 20 moles, preferably 5 to 15 moles, per mole of the compound of the formula (II).

As the base, there can be used NaOH, KOH, NaH, sodium methxoide, sodium ethoxide, pyridine, piperidine, morpholine, triethylamine, N-methylpyrrolidine, etc.

As the solvent, there can be used alcohols such as methanol, ethanol, propanol, isopropanol, etc.; aromatic 65 hydrocarbons such as benzene, toluene, etc.; cyclic ethers such as 1,4-dioxane, tetrahydrofuran, etc.

The reaction is carried out usually at 20° to 100° C., preferably 25° to 65° C. for usually 1 to 20 hours, preferably 2 to 10 hours.

The resulting product is purified by a conventional method such as distillation, column chromatography, etc. to yield the compound of the formula (VIII).

The compound of the formula (VIII) is converted to the compound of the formula (I) in the same manner as described in the reaction scheme (2).

When R^1 and R^2 are different, the reaction scheme (2) is preferable from the viewpoint of practical production.

The compound of the formula (I) is effectively used in a chemical amplified resist material wherein there is used a polymer having a property of alkali-soluble by the action of an acid. When the resist material is exposed to KrF excimer laser light or the like, the compound of the formula (I) present in the exposed portion generates an acid by the following reaction scheme (4):

$$R^{1}SO_{2}CSO_{2}R^{2} \xrightarrow{hv} R^{1}SO_{2}CSO_{2}R^{2} \xrightarrow{2) H_{2}O}$$

$$R^{1}SO_{2}CSO_{2}R^{2} \xrightarrow{hv} R^{1}SO_{2}CSO_{2}R^{2} \xrightarrow{2) H_{2}O}$$

$$R^{1}SO_{2}CHSO_{3}H, \text{ or } R^{2}$$

$$HO_{3}SCHSO_{2}R^{2}$$

$$R^{1}$$

When heat treatment is applied after the exposure step, functional groups of the polymer in the resist material is subjected to a chemical change by the acid to become alkali-soluble by the following reaction scheme (5):

$$\begin{array}{c} \begin{array}{c} \begin{array}{c} \begin{array}{c} \begin{array}{c} \\ \\ \end{array} \end{array} \end{array} \begin{array}{c} \begin{array}{c} \\ \\ \end{array} \end{array} \begin{array}{c} \\ \end{array} \\ \end{array} \begin{array}{c} \\$$

The resulting alkali-soluble polymer is released into an alkali developing solution at the time of development.

On the other hand, since non-exposed portions do not generate an acid, no chemical change takes place even if 55 heat treated to produce no alkali-soluble groups. Further, since the compound of the formula (I) has a dissolution inhibiting effect, the non-exposed portions become difficultly soluble in the alkali developing solution.

As mentioned above, when pattern formation is carried out by using a chemical amplified resist material containing the compound of the formula (I), a large difference in solubility in the alkali developing solution takes place between the exposed portions and the non-exposed portions. As a result, there can be formed a positive tone pattern having good contrast. Further, as is clear from the reaction scheme (5), since the acid generated by exposure to light acts catalytically, not only the necessary amount of acid can

be produced by the exposure to light, but also the light exposure energy amount can be reduced.

Needless to say, the compound of the formula (I) is useful for producing semiconductors and can be used as a photosensitive reagent in the field of applying photo reaction such 5 as photograving, printing plate materials, etc.

The present invention is illustrated by way of the following Examples.

REFERENCE EXAMPLE 1

(1) Free radical polymerization of p-tert-butoxystyrene

A solution of p-tert-butoxystyrene (17.6 g) in toluene containing catalytic amount of 2,2'-azobisisobutyronitrile (AIBN) was heated at 80° C. for 6 hours under nitrogen. After cooling, the reaction mixture was poured into methanol and the polymer was precipitated. The polymer was filtered, washed with methanol and dried under reduced pressure to afford 15. 5 g of poly(p-tert-butoxystyrene) as white powders.

(2) Synthesis of poly(p-tert-butoxystyrene-p-hydroxystyrene)

A solution of poly(p-tert-butoxystyrene) (15.0 g) obtained in above (1) and hydrochloric acid (10 ml) in 1,4-dioxane was refluxed for 1.5 hours with stirring. The mixture was cooled, poured into water and the white solid was precipitated. The polymer was filtered, washed and dried under reduced pressure to afford 11.8 g of the title compound as white powders having Mw10000 (GPC with polystyrene calibration). The composition of the polymer was found to be p-tert-butoxystyrene and p-hydroxystyrene in a molar ratio of ca 1:1 based on ¹HNMR analysis

REFERENCE EXAMPLE 2

Synthesis of p-toluenesulfonylazide

After dissolving sodium azide (22.5 g, 0.35 mole) in a small amount of H₂O, the resulting solution was diluted with a 90% ethanol aqueous solution (130 ml). To this, an ethanol solution dissolving p-toluenesulfonyl chloride (60 g, 0.32 mole) was added dropwise at 10-25° C., followed by reaction at room temperature for 2.5 hours. The reaction solution was concentrated at room temperature under reduced pressure. The resulting oily residue was washed with H₂O several times and dried over anhydrous MgSO₄. After removing the drying agent by filtration, there was obtained 50.7 g of the title compound as a colorless oil.

¹HNMR δ ppm (CDCl₃): 2.43 (3H, s, <u>CH</u>₃), 7.24 (2H, d, J=8Hz, Ar 3-H, 5-H), 7.67 (2H, d, J=8Hz, Ar 2-H, 6-H). IR (Neat) vcm^{-1} : 2120 (—N₃).

EXAMPLE 1

Synthesis of bis(cyclohexylsulfonyl)diazomethane

(1) Synthesis of bis(cyclohexylsulfonyl)methane

To cyclohexylthiol (20.2 g, 0.17 mole), an ethanol solution dissolving potassium hydroxide (12.0 g, 0.21 mole) was added dropwise at room temperature and mixture was stirred at 30°±5° C. for 30 minutes. Then methylene chloride (18.2 g, 2.14 mole) was added to this mixture and reacted with stirring at 50°±5° C. for 6 hours. After standing at room temperature overnight, the reaction mixture was diluted with ethanol (55 ml) and added with sodium tungstate (0.4 g). 65 Then, 30% hydrogen peroxide (50 g, 0.44 mole) was added dropwise to this solution at 45°-50° C., reacted with stirring

8

for 4 hours at the same temperature, then added with H₂O (200 ml) and standed overnight at room temperature. The precipitate was filtered, washed with H₂O and dried. The resultant solid was recrystallized from ethanol to give 15.5 g of bis(cyclohexylsulfonyl)methane as white needles.

mp. 137°-139° C.

¹HNMR δ ppm (CDCl₃) 1.13-2.24 (20H, m, cyclohexylic CH₂×10), 3.52-3.66 (2H, m, cyclohexylic CH×2), 4.39 (2H, s, CH₂).

IR (KBr-disk) ν cm⁻¹: 1320, 1305.

(2) Synthesis of bis(cyclohexylsulfonyl) diazomethane

To a solution of sodium hydroxide (1.7 g) in a 60% ethanol aqueous solution (70 ml), bis(cyclohexylsulfonyl) methane (12.1 g, 0.04 mole) obtained in above (1) was added, then an ethanol solution of p-toluenesulfonyl azide (8.2 g, 0.04 mole) obtained in Reference Example 2 was added dropwise at 5°-10° C., followed by the reaction at room temperature for 7 hours. After standing at room temperature overnight, the precipitate was filtered, washed with ethanol and dried. The resultant solid was recrystallized from acetonitrile to give 8.0 g of bis(cyclohexylsulfonyl) diazomethane as pale yellow prisms.

mp. 130°-131° C.

¹HNMR δ ppm (CDCl₃): 1.13-2.25 (20H, m, cyclohexylic $C_{H_2} \times 10$), 3.36-3.52 (2H, m, cyclohexylic $C_{H_2} \times 10$).

IR (KBr-disk) v cm⁻¹: 2130 (CH₂), 1340, 1320.

Ultraviolet spectrophotometric characteristics of bis (cyclohexylsulfonyl)diazomethane in acetonitrile solution was shown in FIG. 1. It is clear that bis(cyclohexylsulfonyl) diazomethane of the present invention shows good transmittance between 240 and 300 nm.

EXAMPLE 2

Synthesis of cyclohexylsulfonylethylsulfonyldiazomethane

(1) Synthesis of chloromethyl cyclohexylsulfide

To a mixture of cyclohexylthiol (20.2 g, 0.17 mole) and 80% paraformaldehyde (6.5 g, 0.17 mole), dry hydrogen chloride was introduced at -8°-0° C., then anhydrous calcium chloride was added and stirring was violently continued at 0° C. for 3 hours. After removing the precipitate by filtration, the filtrate was distilled under reduced pressure to afford 16.5 g of chloromethylcyclohexylsuflide as a colorless oil having a boiling point of 100°-103° C./14 mmHg.

(2) Synthesis of cyclohexylsulfonylethylsulfonylmethane

To ethanethiol (5.7 g, 0.09 mole), an ethanol solution dissolving potassium hydroxide (6 g, 0.09 mole) was added dropwise at room temperature and mixture was stirred for 15 minutes. Then chroromethylcyclohexylsulfide (15 g, 0.09 mole) obtained in above (1) was added dropwise to this mixture at 10°±5° C. and reacted with stirring at that temperature for 3 hours. After standing at room temperature overnight, the reaction mixture was diluted with ethanol (30 ml) and H₂O (30 ml) and added with sodium tungstate (0.3 g). Then, 30% hydrogen peroxide (53 g, 0.47 mole) was added dropwise to this solution at 45°-50° C., followed by reaction for 6 hours at the same temperature, then added with H₂O (300 ml) and standed overnight at room temperature. The precipitate was filtered, washed with H₂O and

dried. The resultant solid (19 g) was recrystallized from ethanol to give 15.5 g of cyclohexylsulfonylethylsulfonylmethane as white needles.

mp: 89°-91° C.

¹HNMR δ ppm (CDCl₃): 1.13-2.24 (13H, m, cyclohexylic $C_{H_2} \times 5$ and $C_{H_2} C_{H_3} = 7.3$ Hz, $C_{H_2} C_{H_3} = 7.3$ Hz

(3) Synthesis of cyclohexylsulfonyl ethylsulfonyldiazomethane

To a solution of sodium hydroxide (1.7 g) in a 60% ethanol aqueous solution (70 ml), cyclohexylsulfonylethylsulfonylmethane (10.2 g, 0.04 mole) obtained in above (2) was added. Then an ethanol solution of p-toluenesulfonyl azide (8.2 g, 0.04 mole) obtained in Reference Example 2 was added dropwise at 5°-10° C., followed by reaction at room temperature for 7 hours. After standing at room temperature overnight, the reaction mixture was extracted with ethyl acetate (25 ml×3), the organic layer was

10

Industries, Ltd.; eluent, n-hexane/ethyl acetate/methylene cloride= $8/1/0 \rightarrow 7/1/1(v/v)$]to give 4.1 g of cyclohexylsulfonylethylsulfonyldiazomethane as pale yellow crystals.

¹HNMR δ ppm (CDCl₃): 1.13-2.27 (13H, m, cyclohexylic $CH_2 \times 5$ and CH_2CH_3), 3.38-3.54 (3H, m, cyclohexylic CH_3 and CH_2CH_3).

EXAMPLES 3-5

Using various thiol compounds of the formula (II) as a starting material, the syntheses were carried out in the same manner as described in Example 1 to give the corresponding bis(alkylsulfonyl)diazomethane. The results are summarized in Table 1.

TABLE 1

Example	R1	Appearance (purification)	m.p.	¹ HNMR δ ppm (CDCl ₃)	IR (KBr)
3	CH ₃ CH——	pale yellow needles (recrystallization from methanol)	82~84° C.	1.46(12H, d, J=7Hz, CH ₃ CH × 2) CH ₃	2120 cm ⁻¹
				3.74(2H, m, J=7Hz, CH ₃ × 2) CH ₃	1340 cm ⁻¹ 1320 cm ⁻¹
4		pale yellow needles (recrystallization from ethanol)	121~121.5° C.	1.52(18H, s, $C\underline{H}_3 \times 6$)	2120 cm ⁻¹ 1330 cm ⁻¹ 1315 cm ⁻¹
5	CHCH ₂ —CHCH ₃	pale yellow oil (column separation: - silica gel, wako Gel C-200; eluent, n-hexane/ethyl acetate = 20/1)		1.14(12H, d, J=7Hz, CH_3 CH_3 2.37(2H, m, CH_3 CH_3 CH_3 CH_3 CH_3	2120 cm ⁻¹
				3.38(4H, d, J=7Hz, ——SO ₂ CH ₂ CH × 2)	1350 cm ⁻¹ 1330 cm ⁻¹

separated, washed with H₂O and dried over anhydrous MgSO₄. After removing the drying agent by filtration, the solvent was evaporated in vacuo, the resultant residue (12 g) 65 was subjected to column separation [silica gel, Wakogel C-200, a trade name, manufactured by wako Pure Chemical

EXAMPLES 6 and 7

Using various thiol compounds of the formula (II) and of the formula (VII) severally as a straight material, the syntheses were carried out in the same manner as described in

Example 2 to give the corresponding diazomethane derivatives. The results are summarized in Table 2.

ml) and H₂O (4 ml), 30% hydrogen peroxide (21 g, 0.19 mole) was added dropwise at 45°-50° C., then reacted with

TABLE 2

Example	R1	R2	Appearance (purification)	m.p.	¹ HNMR δ ppm (CDCl ₃)	IR (KBr)
6	CH ₃ CH ₃ CH ₃ CH ₃	CH ₃ —	pale yellow needles (recrystallization from ethanol)	90.5~92° C.	1.51(9H, s, —C(C <u>H₃</u>) ₃) 3.39(3H, s, —SO ₂ C <u>H₃</u>)	2120 cm ⁻¹ 1335 cm ⁻¹ 1310 cm ⁻¹
7	CH ₃ ——C——————————————————————————————————	H	pale yellow needles (recrystallization from n-hexane/ ethyl ether)	86~88° C.	1.13-2.27(19H, m, HHHHHH HHH HHH	$C(CH_3)_3)$
					3.47-3.63(1H, m, H)	1330 cm ⁻¹ 1315 cm ⁻¹

COMPARATIVE EXAMPLES 1-3

Using various thiol compounds having a straight-chain alkyl group as a starting material, the syntheses were carried out in the same manner as described in Example 1 to afford the corresponding bis(alkylsulfonyl)diazomethane. The results are summarized in Table 3.

stirring under reflux for 8 hours and standed at room temperature overnight. The reaction solution was poured into H₂O (400 ml), and the precipitate was filtered, washed with H₂O and dried. The resultant solid (9.5 g) was recrystallized from ethanol to effort 7.8 g of bis(methylsulfonyl) methane as white leaflets.

m.p.: 148°-149.5° C.

TABLE 3

 $R - SO_2 - C - SO_2 - R$

			N_2		
Comparative Example	R	Appearance (purification)	m.p.	¹ HNMR δ ppm (CDCl ₃)	IR
1	C ₂ H ₅ —	pale yellow needles (recrystallization	88.7~89.7° C.	1.46(6H, t, J=7.3Hz, — $CH_2C\underline{H_3} \times 2$)	2140 cm ⁻¹
		from methanol)		3.48(4H, q, J=7.3Hz, -CH2CH3 × 2)	1335 cm ⁻¹
2	CH ₃ (CH ₂) ₃ —	pale yellow needles (column separation:	44~47° C.	$0.98(6H, t, J=7Hz, -CH_3 \times 2)$	2145 cm^{-1}
		silica gel,		1.42-1.56(4H, m,	
		Wakogel C-200; eluent, n-hexane/ ethyl acetate =		$-CH_2CH_3 \times 2$) 1.79-1.90(4H, $-SO_2CH_2CH_2 \times 2$)	1350 cm^{-1}
		20/1)		3.38(4H, d, J=7Hz,	1335 cm^{-1}
3	CH ₃ (CH ₂) ₇ —	pale yellow oil (column separation:		$-SO_2CH_2CH_2 \rightarrow 2$ 0.82-1.94(30H, m $CH_3(CH_2)_6 \rightarrow 2$)	2120 cm^{-1}
		silica gel, Wakogel C-200;		3.43(4H, t, —SO ₂ C \underline{H}_2 — × 2)	1340 cm^{-1}
		eluent, n-hexane/ ethyl acetate = 3/1			

COMPARATIVE EXAMPLE 4

Synthesis of bis(methylsulfonyl)diazomethane

(1) Synthesis of bis(methylsulfonyl)methane

To a solution of methyl methylsulfinylmethylsulfide (7.0 g, 0.06 mole) and sodium tungsate (0.14 g) in methanol (40

¹HNMR δ ppm (CDCl₃): 3.26 (6H, s, C<u>H</u>₃×2), 4.43 (2H, s, C<u>H</u>₂)
IR (KBr-disk) ν cm⁻¹: 1310.

(2) Synthesis of bis(methylsulfonyl)diazomethane

Using bis(methylsulfonyl)methane (7.5 g, 0.04 mole) obtained in above (1), the reaction was carried out in the

60

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same manner as described in Example 1, (2), and the crude solid (4.5 g) was chromatographed on silica gel (Wakogel C-200) with n-hexane/ethyl acetate $(8/1 \rightarrow 4/1 \rightarrow 3/1)$ as eluent to give 2.5 g of bis(methylsulfonyl)diazomethane as white crystals.

m.p.: 120°-124° C. ¹HNMR δ ppm (CDCl₃): 3.37 (6H, s, C<u>H</u>₃×2). IR (KBr-disk) v cm⁻¹: 2145 (CN₂), 1335, 1320.

APPLICATION EXAMPLE 1

A resist material having the following composition was prepared:

Poly(p-tert-butoxystyrene-p-	6.0 g
hydroxystyrene) [Polymer obtained in Reference	
Example 1, (2)] Bis(cyclohexylsulfonyl)diazomethane [Photoacid generator obtained in	0.3 g
Example 1, (2)] Diethylene glycol dimethyl ether	13.7 g

Using the resist material, a pattern was formed as shown in FIG. 2. That is, the resist material was spin coated on a substrate 1 such as a 6 inch silicon wafer in diameter and prebaked by a hot plate at 90° C. for 90 seconds to give a resist material film 2 of 1.0 µm thick [FIG. 2 (a)]. The film ³⁰ 2 was selectively exposed to KrF excimer laser light 3 of 248.4 nm via a mask 4 at a dose of 25 mJ/cm² using a projection aligner (5:1 reduction, NA=0.42) [FIG. 2 (b)]. The exposed film was heated at 110° C. for 90 seconds, then development was carried out using a conventional alkali 35 wherein R1 is a branched or cyclic alkyl group having 3 to aqueous solution (2.38% tetramethylammonium hydroxide aqueous solution) for 60 seconds to remove exposed regions of the film 2 by dissolution to give a positive pattern 2a without loss of film thickness in the unexposed regions [FIG. 2(c)]. The positive pattern had an aspect ratio of ca. 87 degree and 0.3 µm lines and spaces were resolved.

APPLICATION EXAMPLES 2 to 7

Resist materials were prepared in the same manner as described in Application Example 1 except for using the diazodisulfone compounds obtained in Examples 2 to 7 as the photoacid generator. Patterns were formed on semiconductor substrates in the same manner as described in Application Example 1. The results are shown in Table 4.

TABLE 4

Application Example No.	Photoacid generator	Exposure energy amount (mJ/cm ²)	Resolution (µm L/S)
2	Example 3	25	0.3
3	Example 4	25	0.3
4	Example 5	30	0.3
5	Example 2	30	0.3
6	Example 6	30	0.3
7	Example 7	25	0.3

As is clear from Table 4, good positive tone patterns are 65 formed by using the resist materials containing the compound of the formula (I) as the photoacid generator.

14

REFERENCE EXAMPLES 3 to 6

Resist materials were prepared in the same manner as described in Application Example 1 except for using the bis(straight-chain alkylsulfonyl)diazomethanes obtained in Comparative Examples 1 to 4. Using the resist materials, patterns were tried to form on semiconductor substrates in the same manner as described in Application Example 1, but no positive tone patterns were formed, since non-exposed portions were dissolved at the time of development.

These results show that the compounds of the formula (I) of the present invention obtained by introducing a bulky alkyl group into at least one of R¹ and R² moisties of the formula (I) play an important role to exhibit dissolution inhibiting effect for the alkali developing solution.

As mentioned above, when the photosensitive resist materials containing the diazodisulfone compounds of the formula (I) of the present invention are used for a light source of 300 nm or less such as deep UV light, KrF excimer laser light (248.4 nm), etc., fine patterns with good shapes of submicron order can easily be obtained.

The compound of the formula (I) of the present invention exhibits remarkable effects as the photoacid generator when exposed to not only deep UV light, KrF excimer laser light, but also ArF excimer laser light, electron beams, and X-rays.

What is claimed is:

[1. A diazodisulfone compound of the formula:

$$\begin{array}{c} R^1SO_2CSO_2R^2 \\ \parallel \\ N_2 \end{array} \tag{I}$$

8 carbon atoms; and R² is a straight-chain, branched or cyclic alkyl group having 1 to 8 carbon atoms.]

[2. A diazodisulfone compound according to claim 1, wherein R¹ is a cyclopentyl group, a cyclohexyl group, an isopropyl group, a sec-butyl group, a tert-butyl group or an isoamyl group; and R² is a methyl group, an ethyl group, a cyclopentyl group, a cyclohexyl group, an isopropyl group, a sec-butyl group, a tert-butyl group or an isoamyl group.]

[3. A diazodisulfone compound according to claim 1, which is

bis(cyclohexylsulfonyl)diazomethane, cyclohexylsulfonylethylsulfonyldiazomethane, 50 bis(isopropylsulfonyl)diazomethane, bis(tert-butylsulfonyl)diazomethane, bis(sec-butylsulfonyl)diazomethane, tert-butylsulfonylmethylsulfonyldiazomethane, tert-butylsulfonylcyclohexylsulfonyldiazomethane, bis(cyclopentylsulfonyl)diazomethane, cyclopentylsulfonyl-tert-butylsulfonyldiazomethane, or bis(isoamylsulfonyl)diazomethane.]

[4. A diazodisulfone compound of the formula:

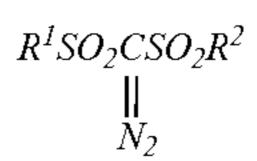
$$\begin{array}{c} R^1SO_2CSO_2R^2 \\ \parallel \\ N_2 \end{array}$$

60

wherein R¹ is a branched or cyclic alkyl group having 3 to 8 carbon atoms; and R² is a branched or cyclic alkyl group having 3 to 8 carbon atoms.]

- [5. A compound according to claim 4, wherein R¹ is a branched alkyl group having 3 to 8 carbon atoms; and R² is a branched alkyl group having 3 to 8 carbon atoms.]
- [6. A compound according to claim 4, wherein R¹ is a cyclic alkyl group having 3 to 8 carbon atoms; and R² is a cyclic alkyl group having 3 to 8 carbon atoms.]
- 7. A [compound according to claim 4,] diazodisulfone 10 compound of the formula:

16



wherein R¹ is a branched alkyl group having 3 to 8 carbon atoms; and R² is a cyclic alkyl group having 3 to 8 carbon atoms.

* * * *